

FAIRCHILD

A Schlumberger Company

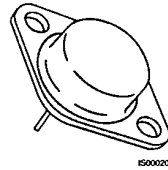
IRF140-143/IRF540-543 T-39-13
N-Channel Power MOSFETs,
27 A, 60-100 V

Power And Discrete Division

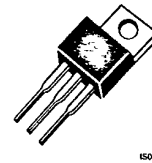
Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high power, high speed applications, such as switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers and high energy pulse circuits.

- Low $R_{DS(on)}$
- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $V_{DS(on)}$, Specified at Elevated Temperature
- Rugged
- Low Drive Requirements
- Ease of Paralleling

TO-204AE

IRF140
IRF141
IRF142
IRF143

TO-220AB

IRF540
IRF541
IRF542
IRF543

Product Summary

Part Number	V_{DSS}	$R_{DS(on)}$	I_D at $T_C = 25^\circ\text{C}$	I_D at $T_C = 100^\circ\text{C}$	Case Style
IRF140	100 V	0.085 Ω	27 A	17 A	TO-204AE
IRF141	60 V	0.085 Ω	27 A	17 A	
IRF142	100 V	0.11 Ω	24 A	15 A	
IRF143	60 V	0.11 Ω	24 A	15 A	
IRF540	100 V	0.085 Ω	27 A	17 A	TO-220AB
IRF541	60 V	0.085 Ω	27 A	17 A	
IRF542	100 V	0.11 Ω	24 A	15 A	
IRF543	60 V	0.11 Ω	24 A	15 A	

Notes

For information concerning connection diagram and package outline, refer to Section 7.

IRF140-143/IRF540-543

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Maximum Ratings

Symbol	Characteristic	Rating IRF140/142 IRF540/542	Rating IRF141/143 IRF541/543	Unit
V_{DS}	Drain to Source Voltage ¹	100	60	V
V_{DGR}	Drain to Gate Voltage ¹ $R_{GS} = 20 \text{ k}\Omega$	100	60	V
V_{GS}	Gate to Source Voltage	± 20	± 20	V
T_J, T_{stg}	Operating Junction and Storage Temperatures	-55 to +150	-55 to +150	°C
T_L	Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s	275	275	°C

Maximum Thermal Characteristics

		IRF140-143	IRF540-543	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.0	1.0	°C/W
P_D	Total Power Dissipation at $T_C = 25^\circ\text{C}$	125	125	W
I_{DM}	Pulsed Drain Current ²	108	108	A

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
Off Characteristics					
$V_{(BR)DSS}$	Drain Source Breakdown Voltage ¹			V	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$
	IRF140/142/540/542	100			
	IRF141/143/541/543	60			
I_{DSS}	Zero Gate Voltage Drain Current		250	μA	$V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0 \text{ V}$
			1000	μA	$V_{DS} = 0.8 \times \text{Rated } V_{DSS}, V_{GS} = 0 \text{ V}, T_C = 125^\circ\text{C}$
I_{GSS}	Gate-Body Leakage Current		± 100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
	IRF140-143		± 500		
	IRF540-543		± 500		
On Characteristics					
$V_{GS(th)}$	Gate Threshold Voltage	2.0	4.0	V	$I_D = 250 \mu\text{A}, V_{DS} = V_{GS}$
$R_{DS(on)}$	Static Drain-Source On-Resistance ²			Ω	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$
	IRF140/141/540/541		0.085		
	IRF142/143/542/543		0.11		
g_{fs}	Forward Transconductance	6.0		S (Ω)	$V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$

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Electrical Characteristics (Cont.) ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
Dynamic Characteristics					
C_{iss}	Input Capacitance		1600	pF	$V_{DS} = 25\text{ V}$, $V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$
C_{oss}	Output Capacitance		800	pF	
C_{rss}	Reverse Transfer Capacitance		300	pF	

Switching Characteristics ($T_C = 25^\circ\text{C}$, Figures 1, 2)³

$t_{d(on)}$	Turn-On Delay Time		30	ns	$V_{DD} = 45\text{ V}$, $I_D = 15\text{ A}$ $V_{GS} = 10\text{ V}$, $R_{GEN} = 4.7\ \Omega$ $R_{GS} = 4.7\ \Omega$
t_r	Rise Time		60	ns	
$t_{d(off)}$	Turn-Off Delay Time		80	ns	
t_f	Fall Time		30	ns	
$t_{d(on)}$	Turn-On Delay Time		60	ns	$V_{DD} = 25\text{ V}$, $I_D = 15\text{ A}$ $V_{GS} = 10\text{ V}$, $R_{GEN} = 50\ \Omega$ $R_{GS} = 50\ \Omega$
t_r	Rise Time		450	ns	
$t_{d(off)}$	Turn-Off Delay Time		150	ns	
t_f	Fall Time		200	ns	
Q_g	Total Gate Charge		60	nC	$V_{GS} = 10\text{ V}$, $I_D = 34\text{ A}$ $V_{DD} = 35\text{ V}$

Symbol	Characteristic	Typ	Max	Unit	Test Conditions
Source-Drain Diode Characteristics					
V_{SD}	Diode Forward Voltage				
	IRF140/141/540/541	2.0	2.5	V	$I_S = 27\text{ A}$; $V_{GS} = 0\text{ V}$
	IRF142/143/542/543	2.0	2.3	V	$I_S = 24\text{ A}$; $V_{GS} = 0\text{ V}$
t_{rr}	Reverse Recovery Time	300		ns	$I_S = 4.0\text{ A}$; $di_S/dt = 25\text{ A}/\mu\text{S}$

Notes

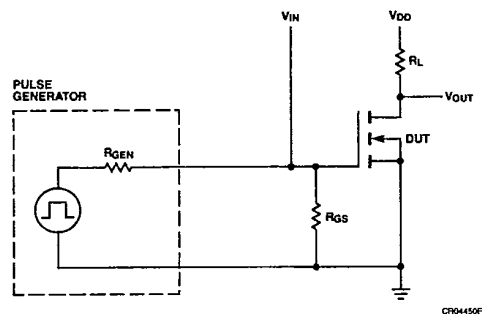
- $T_J = +25^\circ\text{C}$ to $+150^\circ\text{C}$
- Pulse width limited by T_J
- Switching time measurements performed on LEM TR-58 test equipment.

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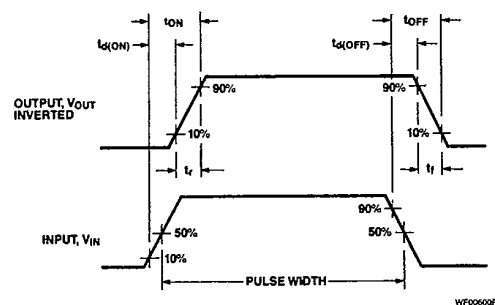
Typical Electrical Characteristics

Figure 1 Switching Test Circuit



CRO4450F

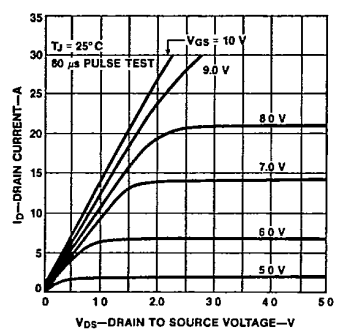
Figure 2 Switching Waveforms



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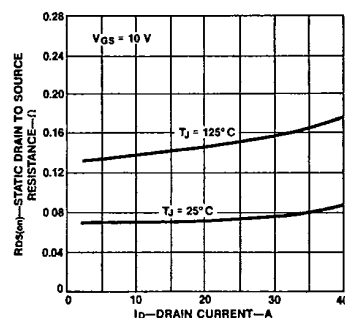
Typical Performance Curves

Figure 3 Output Characteristics



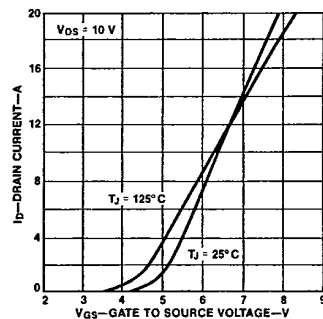
PC10040F

Figure 4 Static Drain to Source Resistance vs Drain Current



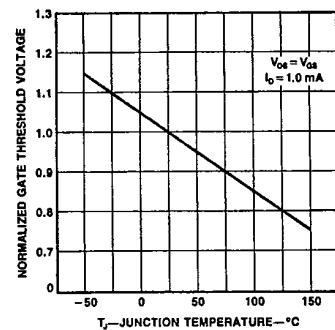
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Figure 5 Transfer Characteristics



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Figure 6 Temperature Variation of Gate to Source Threshold Voltage



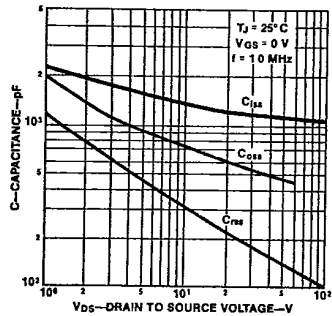
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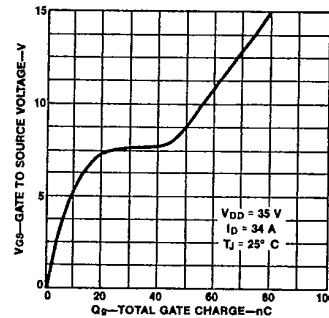
Typical Performance Curves (Cont.)

Figure 7 Capacitance vs Drain to Source Voltage



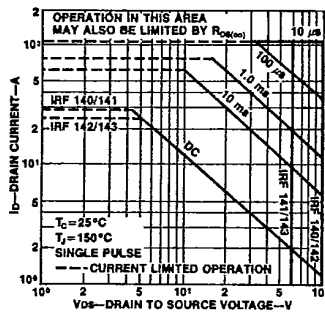
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Figure 8 Gate to Source Voltage vs Total Gate Charge



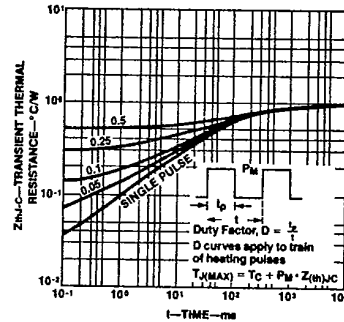
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Figure 9 Forward Biased Safe Operating Area



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Figure 10 Transient Thermal Resistance vs Time



PC10100F